

#### **Features**

- High frequency operation
- High surge forward current capability
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Guard ring for enhanced ruggedness and long term reliability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

### **Typical Applications**

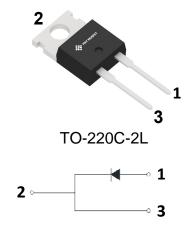
Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

### **Mechanical Data**

 Package: TO-220C-2L
 Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant

 Terminals: Tin plated leads, solderable per J-STD-002 and JESD22-B102

• Polarity: As marked



# Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	MUR810	MUR815	MUR820	MUR840	MUR860
Device marking code			MUR810	MUR815	MUR820	MUR840	MUR860
Repetitive Peak Reverse Voltage	VRRM	٧	100	150	200	400	600
Average Rectified Output Current @60Hz half sine-wave, R-load, Tc(FIG.1)	I <sub>0</sub>	Α	8				
Surge(Non-repetitive)Forward Current @60Hz half sine-wave,1 cycle, Ta=25°C	IFSM	А	100				
Current Squared Time @1ms≤t≤8.3ms Tj=25°C	I <sup>2</sup> t	A <sup>2</sup> s	41				
Storage Temperature	T <sub>stg</sub>	°C	-55 ~ <b>+</b> 150				
Junction Temperature	Tj	$^{\circ}$	-55 ~ <b>+</b> 150				

# **Electrical Characteristics** (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	MUR810	MUR815	MUR820	MUR840	MUR860
Maximum instantaneous forward voltage drop per diode	VFM	V	IFM=8.0A	0.975			1.3	1.5
Maximum DC reverse current at rated DC blocking voltage per diode	IRRM1		VRM=VRRM T <sub>a</sub> =25℃	10				
	IRRM2	uA	VRM=VRRM T <sub>a</sub> =125℃	500				
Reverse Recovery Time	Trr	ns	$I_F$ =0.5A $I_{RM}$ =1A $I_{RR}$ =0.25A	50				

# **Thermal Characteristics** (T<sub>a</sub>=25°C Unless otherwise specified)

PARAMETER		SYMBOL	UNIT	MUR810	MUR815	MUR820	MUR840	MUR860
Thermal Resistance	Between junction and case	$R_{\theta J\text{-}C}$	°CMV	2.0				



# Characteristics (Typical)

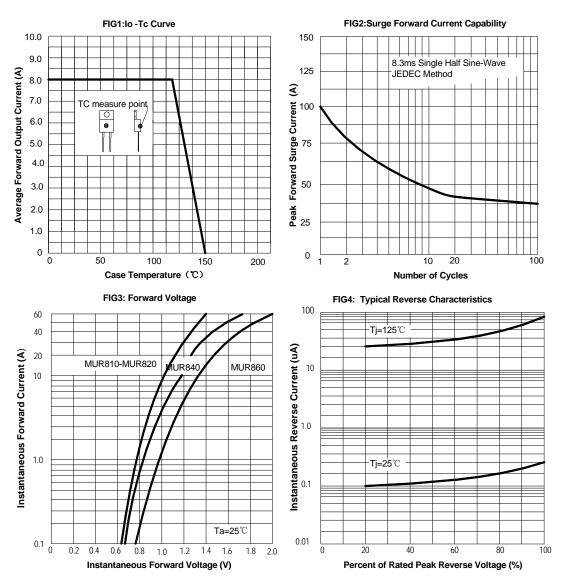
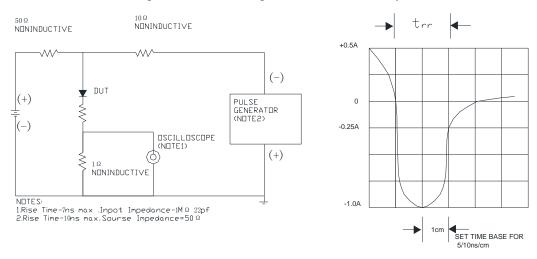
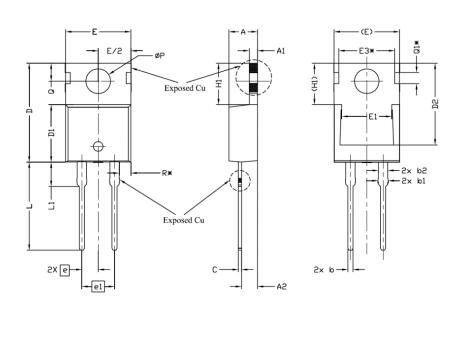


FIG.5 Diagram of circuit and Testing wave form of reverse recovery time





# Package Information TO-220C-2L



SYMBOL	[	NOTES					
STIMBUL	MIN.	NOM.	MAX.	NOTES			
Α	4,24	4.44	4.64				
A1	1.15	1.27	1.40				
A2	2.30	2.48	2.70				
Ф	0.70	0.80	0.90				
b1	1.20	1.55	1.75				
b2	1.20	1,45	1.70				
С	0.40	0.50	0.60				
D	14.70	15.37	16.00	4			
D1	8,82	8,92 9,02					
D2	12.43	12.73 12.83		5			
ш	9.96	10.16	10.36	4,5			
E1	6,86	7,77 8,89		5			
E3*		8.70REF.					
e		2.54BSC					
e1		5.08BSC					
H1	6.30	6.45 6.60		5,6			
١	13.47	13.72 13.97					
L1	3.60	3.80	4.00				
ØP	3.75	3.84	3,93				
Q	2,60	2.80 3.00					
Q1*							
R*		1.82REF.					



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